

## TECHNICAL DATA SHEET

Alloy designation according to ISO 9453:2020:	<b>Sn99,3Cu0,7</b>
Flux designation:	<b>PRO</b>
Product form:	Cored solder wire
Other known alloy markings:	S-Sn99Cu1

### 1. General characteristics

The lead-free solder alloy Sn99,3Cu0,7 is manufactured by Cynel-Unipress in the first smelting of tin and copper. Its chemical composition complies with ISO 9453. Sn99,3Cu0,7 is the most cost-effective alternative to lead-containing solders. It does not contain silver. Alloy is designed for soldering in lead-free technology. It meets the requirements of the RoHS directive. It can be sold on the consumer market and also used by private individuals outside of professional applications.

### 2. Chemical composition and physical characteristics

- 2.1. Tin content: rest
- 2.2. Copper content: 0,5 – 0,9%
- 2.3. Purity class of raw materials used for smelting: min. 99,90%
- 2.4. % composition and maximum values of impurities according to ISO 9453:2020:

Sn	Pb	Sb	Bi	Cu	Au	In	Ag	Al	As	Cd	Fe	Ni	Zn	other
rest	0,0700	0,1000	0,1000	0,5000 - 0,9000	0,0500	0,1000	0,1000	0,0010	0,0300	0,0020	0,0200	0,0100	0,0010	-

- 2.5. Melting point: 227 °C (eutectic alloy)
- 2.6. Specific weight: ~7,31 g/cm<sup>3</sup>
- 2.7. Resistivity: 0,126 μΩ·m
- 2.8. Thermal conductivity: 66 W/m·K
- 2.9. Tensile strength at break: 300 kg/cm<sup>2</sup>
- 2.10. Elongation at break: 21%
- 2.11. Hardness: 9 HB
- 2.12. Recommended soldering temperature (tip): 320 - 360 °C (for nickel plated elements up to 400 °C)

### 3. PRO flux

Halide-free flux based on colophony, excellent for wetting copper and other solder point coatings generally used in electronics. Gentle yet effective, it performs very well in robot-operated processes, as well as in general soldering applications for electronic connections.

- 3.1. Designation according to DIN 8511: SW32
- 3.2. Designation according to ISO 9454-1: 1.1.3
- 3.3. Designation according to J-STD-004: ROL0
- 3.4. Standard flux contents: 1,0% • 1,5% • 2,0% • 2,2% • 2,5% • 3,0% ± 0,2%  
other flux contents in the range from 0,8% to 3,5% possible to agree on
- 3.5. Halide content: 0,0%
- 3.6. Acid number: 305 ±10 mg KOH/g
- 3.7. Copper mirror test: passed (in accordance with J-STD-004 IPC-TM-650 2.3.32D)
- 3.8. Corrosiveness: noncorrosive

### 4. Other information

- 4.1. Available diameters [mm]: 0,25 • 0,38 • 0,50 • 0,56 • 0,70 • 0,80 • 0,90 • 1,00 • 1,20 • 1,50 • 2,00 • 2,50 • 3,00 • 4,00  
Other wire diameters possible to be agreed.
- 4.2. Spools and packaging: Spools 100 g - carton box of 30 pcs  
Spools 250 g - carton box of 5 kg  
Spools 500 g - carton box of 5 kg  
Spools 1 kg - carton box of 10 kg
- 4.3. Expiry date: 5 full years from the end of the year of production given in the product batch number.  
E.g.: batch no. 61112233 = year of manufacture 2016, validity until the end of 2021.
- 4.4. Markings: Spools and carton boxes marked with alloy, flux type, percentage content of flux, diameter, weight and batch number.
- 4.5. Storage: Store at room temperature in a dry place out of reach of children.

The subject of the specification described above complies with Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of hazardous substances in electrical and electronic equipment and with the Commission Delegated Directive (EU) 2015/863 of 31 March 2015, amending Annex II to Directive 2011/65/EU of the European Parliament and of the Council as regards the list of restricted substances as amended. The subject does not contain any of the substances listed in the RoHS Directive, i.e. lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB), polybrominated diphenyl ethers (PBDE), di(2 ethylhexyl phthalate (DEHP), butyl benzyl phthalate (BBP), dibutyl phthalate (DBP), diisobutyl phthalate (DIBP) above 0.1% at a homogeneous level of material, unless it is exempted.

